

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

**KANAYAMA et al.**Atty. Ref.: **1417-495**Serial No. **unknown**Group: **unknown**National Phase of: **PCT/JP2003/009997**International Filing Date: **6 August 2003**Filed: **February 1, 2005**Examiner: **Unknown**For: **LOW-HEAT ACCUMULATING THERMOPLASTIC RESIN  
COMPOSITION AND MOLDED PRODUCT**

\* \* \* \* \*

**February 1, 2005**Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**PRELIMINARY AMENDMENT**

Prior to calculation of the filing fee and in order to place the above identified application in better condition for examination, please amend as follows: